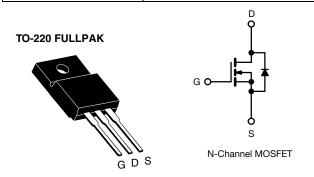


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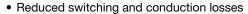
E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.18			
Q _g max. (nC)	86			
Q _{gs} (nC)	11			
Q _{gd} (nC)	24			
Configuration	Single			



FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF22N60E-E3
Lead (Pb)-free and Halogen-free	SiHF22N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	600	V
Gate-Source Voltage			V_{GS}	± 30	v
Outin Dai O and T 150 00 0			I _D	21	
Continuous Drain Current ($T_J = 150 ^{\circ}\text{C}$) e V_{GS} at 10 V $T_C = 25 ^{\circ}\text{C}$ $T_C = 100 ^{\circ}\text{C}$				13	Α
Pulsed Drain Current ^a			I _{DM}	56	
Linear Derating Factor				0.28	W/°C
Single Pulse Avalanche Energy b			E _{AS}	367	mJ
Maximum Power Dissipation			P_{D}	35	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope T _J = 125 °C			dV/dt	70	V/ns
Reverse Diode dV/dt ^d				11	V/IIS
Soldering Recommendations (Peak temperature) c for 10 s				300	°C
Mounting Torque M3 screw				0.6	Nm

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5.1 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.
- e. Limited by maximum junction temperature.



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	65	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	3.6	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 250 μA	=.	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	-	4	V
Cata Carriaga Lagliaga		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-		± 1	μΑ
Zava Cata Valtaga Dvain Cuwant		V _{DS} =	V _{DS} = 600 V, V _{GS} = 0 V		-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 11 A	-	0.15	0.18	Ω
Forward Transconductance	9 _{fs}	V _D	_S = 8 V, I _D = 5 A	-	6.4	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	1920	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 \text{ V},$	-	90	-	
Reverse Transfer Capacitance	C _{rss}	v _{DS} = 100 v, f = 1 MHz		-	6	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	٧, ٥١	/+- 400 V V 0 V	-	73	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		-	263	-	
Total Gate Charge	Qg			-	57	86	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 11 A, V_{DS} = 480 V$	-	11	-	nC
Gate-Drain Charge	Q _{gd}			-	24	-	
Turn-On Delay Time	t _{d(on)}			-	18	36	
Rise Time	t _r	V _{DD} = 380 V, I _D = 11 A,		-	27	54	
Turn-Off Delay Time	t _{d(off)}		= 10 V, $R_q = 4.7 \Omega$	-	66	99	ns
Fall Time	t _f		J	-	35	70	
Gate Input Resistance	R_g	f = 1	MHz, open drain	0.3	0.77	1.2	Ω
Drain-Source Body Diode Characteristic	s						•
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol	-	-	21	_
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	56	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	0 1 17 0 1119 100 1		_	344	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 11 \text{A},$		-	5.3	-	μC
Reverse Recovery Current	I _{RRM}	dl/dt = 100 A/μs, V _R = 25 V		-	28	-	A

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

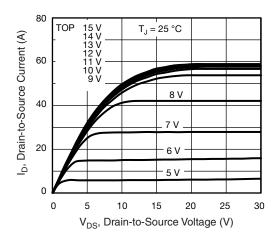


Fig. 1 - Typical Output Characteristics

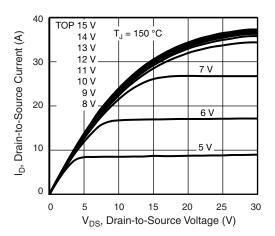


Fig. 2 - Typical Output Characteristics

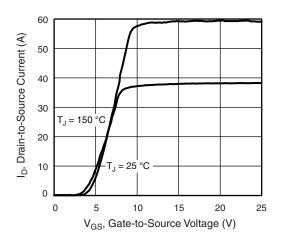


Fig. 3 - Typical Transfer Characteristics

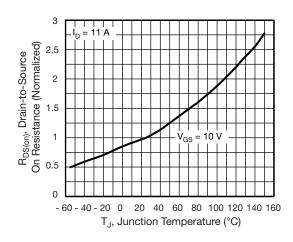


Fig. 4 - Normalized On-Resistance vs. Temperature

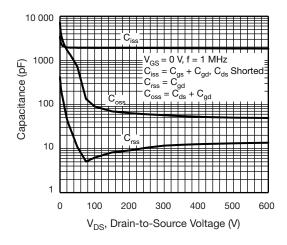


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

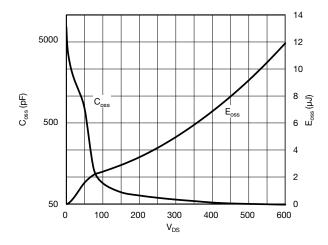


Fig. 6 - Coss and Eoss vs. VDS



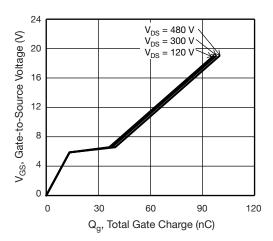


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

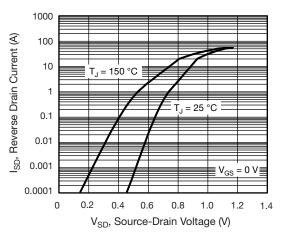


Fig. 8 - Typical Source-Drain Diode Forward Voltage

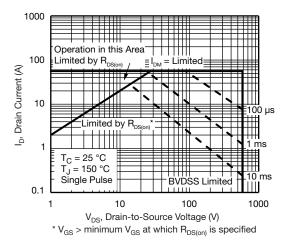


Fig. 9 - Maximum Safe Operating Area

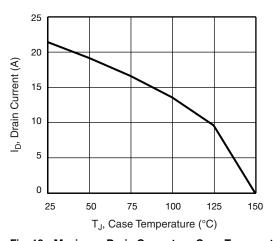


Fig. 10 - Maximum Drain Current vs. Case Temperature

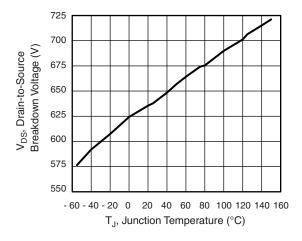


Fig. 11 - Temperature vs. Drain-to-Source Voltage



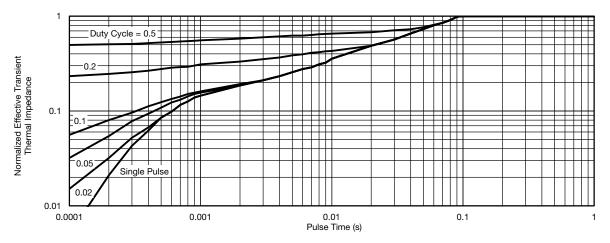


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

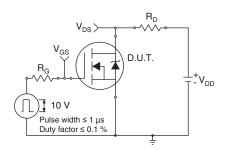


Fig. 13 - Switching Time Test Circuit

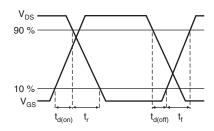


Fig. 14 - Switching Time Waveforms

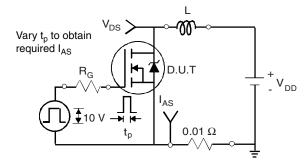


Fig. 15 - Unclamped Inductive Test Circuit

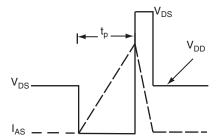


Fig. 16 - Unclamped Inductive Waveforms

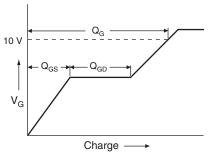


Fig. 17 - Basic Gate Charge Waveform

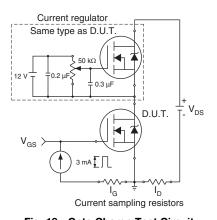
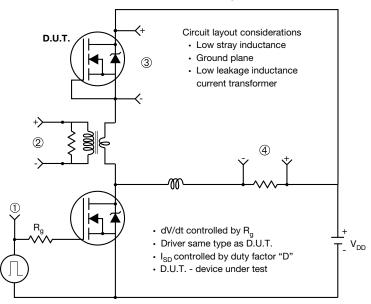


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



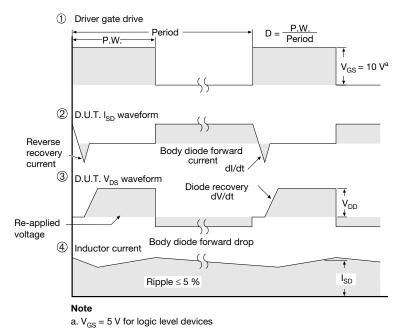


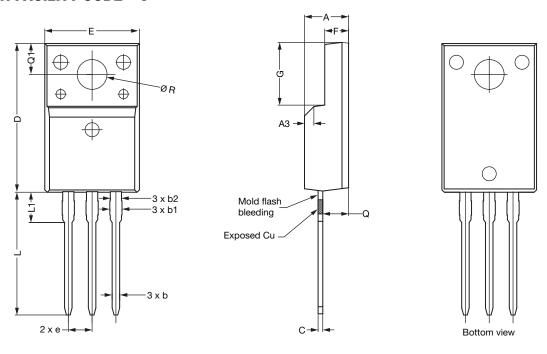
Fig. 19 - For N-Channel

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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9

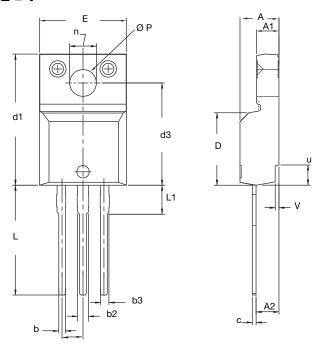


		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
Α	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



OPTION 2: FACILITY CODE = Y



M		ETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
Е	10.360	10.630	0.408	0.419	
е	2.54	2.54 BSC		0.100 BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØΡ	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

ECN: E19-0180-Rev. D, 08-Apr-2019

DWG: 5972

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



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